#### SURFACE MOUNT SCHOTTKY BARRIER DIODE

#### **Features**

- Low Forward Voltage Drop
- Guard Ring Construction for Transient Protection
- Fast Switching Speed
- Low Capacitance
- Surface Mount Package Ideally Suited for Automated Insertion
- Lead, Halogen and Antimony Free, RoHS Compliant "Green" Device (Notes 3 and 4)

### **Mechanical Data**

- Case: SOD-323
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- Polarity: Cathode Band
- Marking Information: See Page 2
- Ordering Information: See Page 2
- Weight: 0.004 grams (approximate)

Top View

## **Maximum Ratings** $@T_A = 25$ % unless otherwise specified

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	70	V
RMS Reverse Voltage	V <sub>R</sub> (RMS)	49	V
Forward Continuous Current	I <sub>FM</sub>	15	mA

#### Thermal Characteristics

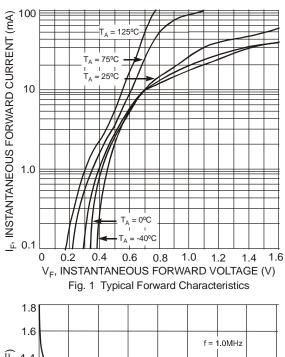
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 1)	$P_{D}$	150	mW
Thermal Resistance, Junction to Ambient Air (Note 1)	$R_{ hetaJA}$	650	°C/W
Operating Temperature Range	$T_J$	-55 to +125	°C
Storage Temperature Range	T <sub>STG</sub>	-55 to +150	°C

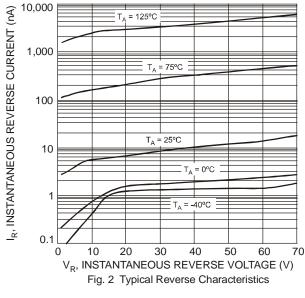
### **Electrical Characteristics** @TA = 25°C unless otherwise specified

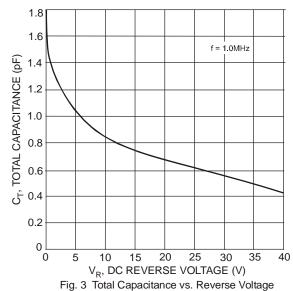
Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Breakdown Voltage (Note 2)	$V_{(BR)R}$	70	_	_	V	$I_R = 10\mu A$
Reverse Leakage Current (Note 2)	I <sub>R</sub>	_	_	200	nA	$V_R = 50V$
Forward Voltage Drop	V <sub>F</sub>	_	_	0.41 1.00	V	$I_F = 1.0 \text{mA}$ $I_F = 15 \text{mA}$
Total Capacitance	C <sub>T</sub>	_	_	2.0	pF	$V_R = 0V$ , $f = 1.0MHz$
Reverse Recovery Time	t <sub>rr</sub>	_	_	1.0	ns	$I_F = I_R = 5.0 \text{mA},$ $I_{rr} = 0.1 \times I_R, R_L = 100 \Omega$

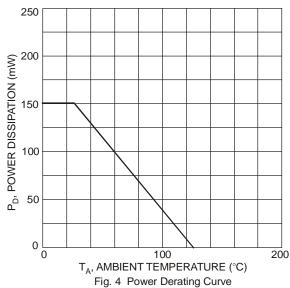
Notes:

- 1. Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
- 2. Short duration pulse test used to minimize self-heating effect.
- 3. No purposefully added lead. Halogen and Antimony Free.
- Product manufactured with Data Code V9 (week 33, 2008) and newer are built with Green Molding Compound. Product manufactured prior to Date Code V9 are built with Non-Green Molding Compound and may contain Halogens or Sb<sub>2</sub>O<sub>3</sub> Fire Retardants.









## Ordering Information (Note 5)

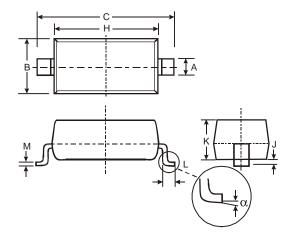
Part Number	er	Case	Packaging
	'-F	SOD-323	3000/Tape & Reel

Notes: 5. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

# **Marking Information**

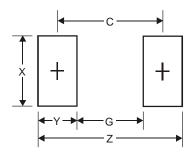


## **Package Outline Dimensions**



SOD-323				
Dim	Min	Max		
Α	0.25	0.35		
В	1.20	1.40		
С	2.30	2.70		
Н	1.60	1.80		
J	0.00	0.10		
K	1.0	1.1		
L	0.20	0.40		
M	0.10	0.15		
α	0°	8°		
All Dimensions in mm				

# **Suggested Pad Layout**



Dimensions	Value (in mm)
Z	3.75
G	1.05
X	0.65
Y	1.35
С	2.40

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